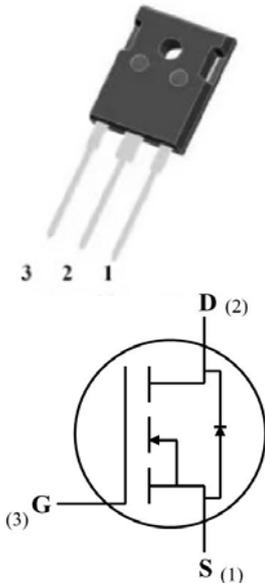


Silicon Carbide Power MOSFET (N-Channel Enhancement)

V_{DS}	650V
I_D (25°C)	98A
$R_{DS(on)}$	25mΩ



Features

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free, RoHS compliant

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical Data

- **Package:** TO-247AB
- **Terminals:** Tin plated leads
- **Polarity:** As marked

■ Maximum Ratings (T_c=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code			D206525NCTYG3		
Drain source voltage @ T _j =25°C	$V_{DS,max}$	V	650	$V_{GS}=0V, I_D=100\mu A$	
Gate source voltage @ T _j =25°C	$V_{GS,max}$	V	-8/+22	Absolute maximum values	
Gate source voltage @ T _j =25°C	$V_{GS,op}$	V	-4/+18	Recommended operational values	
Continuous drain current @ T _c =25°C	I_D	A	98	$V_{GS}=18V, T_c=25^\circ C$	Fig.17
Continuous drain current @ T _c =100°C			67	$V_{GS}=18V, T_c=100^\circ C$	
Pulsed drain current	$I_{D(pulsed)}$	A	265	Pulse width t _p limited by T _{j,max}	Fig.22
Power Dissipation	P_{TOT}	W	365	T _c =25°C, T _j = 175°C	Fig.16
Power Dissipation			182	T _c =100°C, T _j = 175°C	
Operating junction and Storage temperature range	T _j , T _{stg}	°C	-55 to +175		
Soldering temperature	T _L	°C	260	1.6mm (0.063") from case for 10s	
Mounting torque	T _M	Nm	0.6	M3 screw Maximum of mounting process: 3	



YJD206525NCTYG3

■Static Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	V _{GS(th)}	V	2.0	3.0	4.0	V _{DS} =V _{GS} , I _D = 15mA	Fig.4, 11
				2.3		V _{DS} =V _{GS} , I _D = 15mA, T _J =175°C	
Drain source breakdown voltage	V _{(BR)DSS}	V	650			V _{GS} =0V, I _D =100uA	
Gate source leakage current	I _{GSS}	nA		10	100	V _{GS} = 18V, V _{DS} =0V	
Current drain source on-state resistance	R _{DS ON}	mΩ		25	35	V _{GS} =18V, I _D =40A	Fig.5, 6, 7
				28		V _{GS} =18V, I _D =40A, T _J =175°C	
Transconductance	g _f	S		27		V _{DS} =20V, I _D =40A	Fig.4
				26		V _{DS} =20V, I _D =40A, T _J =175°C	

■Dynamic Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	C _{iss}	pF		4121		V _{DS} =400V, V _{GS} =0V, T _J =25°C, f=1MHz, V _{AC} = 25mV	Fig.13, 14
Output capacitance	C _{oss}			173			
Reverse capacitance	C _{rss}			8.2			
Coss stored energy	E _{oss}	uJ		28			Fig.15
Gate source charge	Q _{gs}	nC		40		V _{DS} =400V, V _{GS} =-4/18V, I _D =40A	Fig.12
Gate drain charge	Q _{gd}			69			
Gate charge	Q _g			147			
Internal gate resistance	R _g	Ω		2		f=1MHz	

■Switching Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on switching energy	E _{on}	uJ		125		V _{DD} =400V, V _{GS} =-4/+18V, I _D =40A, R _g =2.4Ω, L=100uH	Fig.19, 20
Turn off switching energy	E _{off}			74			
Turn on delay time	t _{d(on)}	ns		18		V _{DD} =400V, V _{GS} =-4/+18V, I _D =40A, R _g =2.4Ω, L=100uH	Fig.21
Rise time	t _r			20			
Turn off delay time	t _{d(off)}	ns		30			
Fall time	t _f			12			



YJD206525NCTYG3

■Body diode characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	V _{SD}	V		4.8		V _{GS} =-4V, I _{SD} =20A	Fig.8
				3		V _{GS} =0V, I _{SD} =20A, T _j =175°C	Fig.9
Continuous diode forward current	I _S	A		95		T _c =25°C	
Reverse recovery time	t _{rr}	nS		22		V _R =400V, V _{GS} =-4V, I _D =40A, di/dt=1000A/uS	
Reverse recovery charge	Q _{rr}	nC		174			
Peak reverse recovery current	I _{rrm}	A		12			

■Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Typ.
Thermal resistance	R _{θJ-C}	°C/W	0.41

■Typical Characteristics

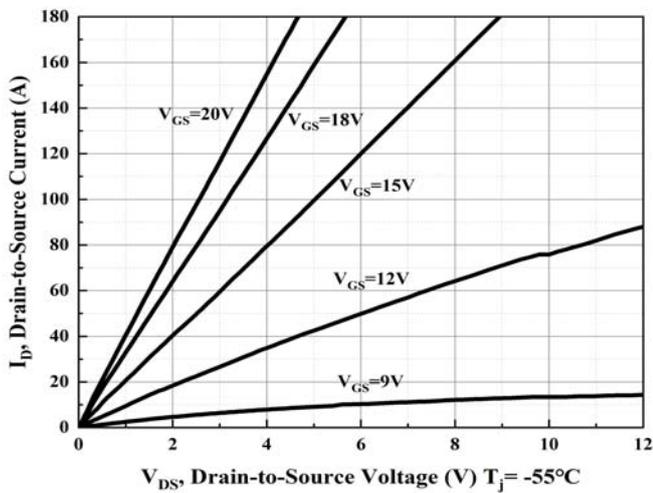


Figure 1. Output Characteristics T_j = -55°C

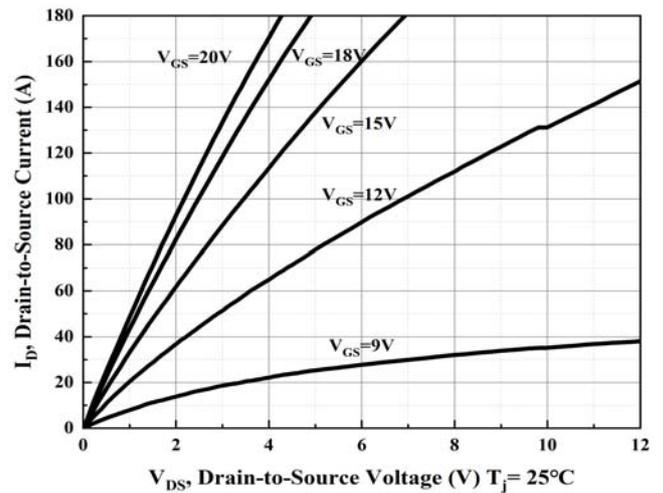


Figure2. Output Characteristics T_j = 25°C

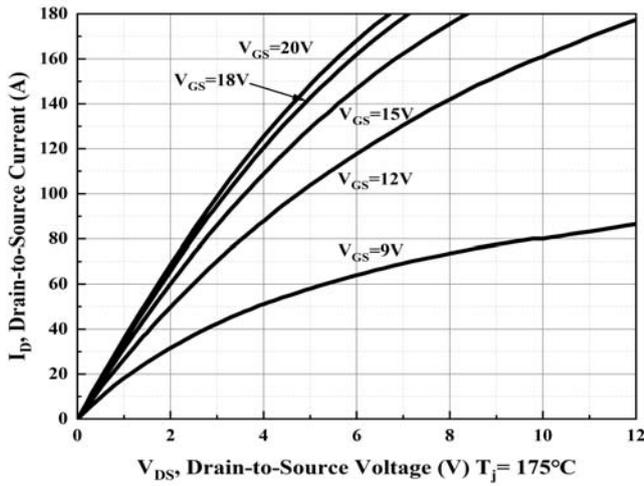


Figure 3. Output Characteristics Tj = 175°C

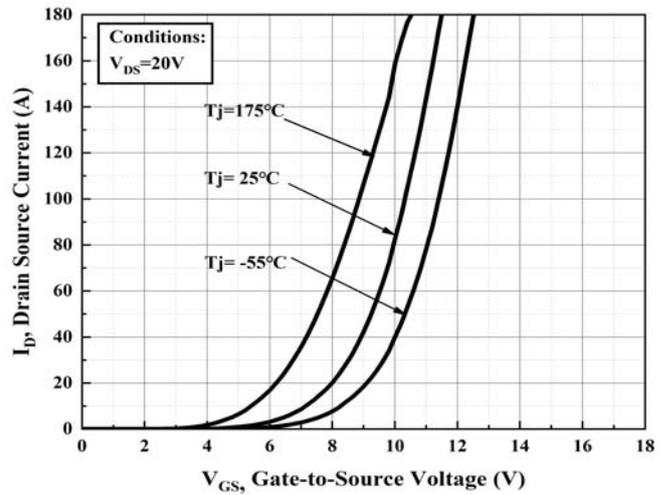


Figure 4. Transfer Characteristics for Various Junction Temperature

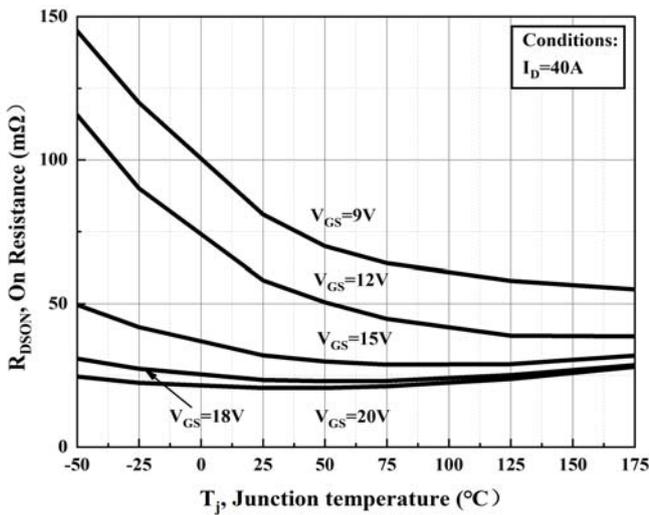


Figure 5. On-resistance vs. Temperature for Various Gate Voltage

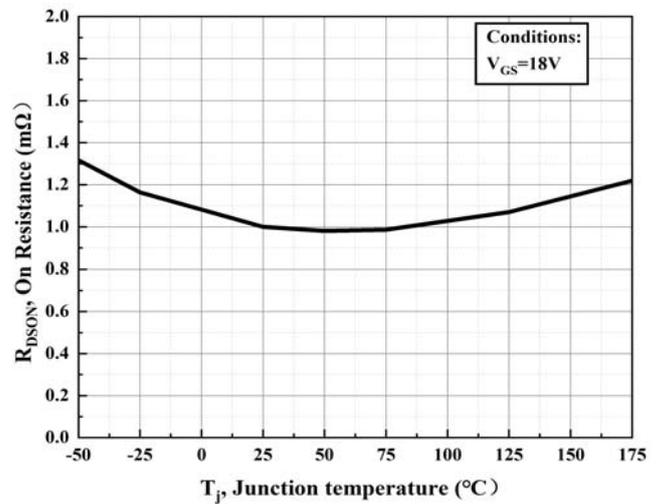


Figure 6. Normalized on-resistance vs. Temperature

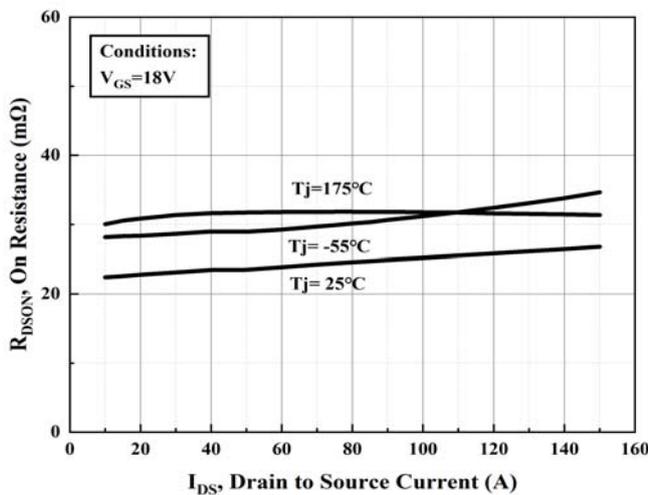


Figure 7. On-resistance vs. Drain Current

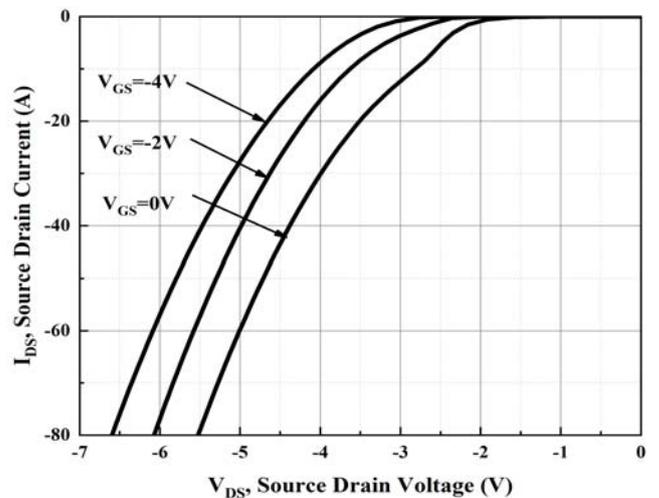


Figure 8. Body Diode Characteristic at Tj = 25 °C

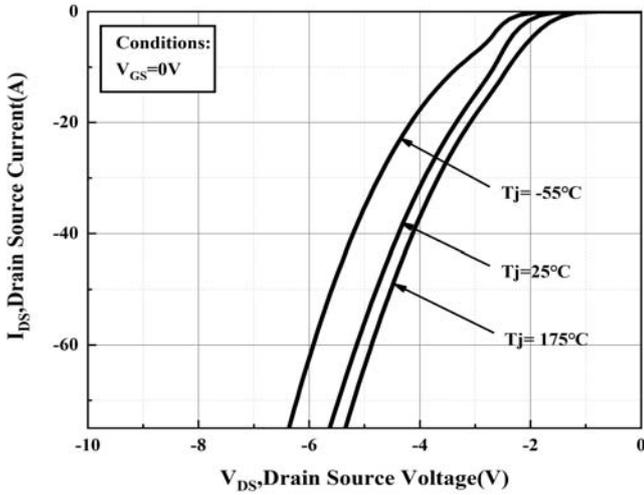


Figure 9. Body Diode Characteristic

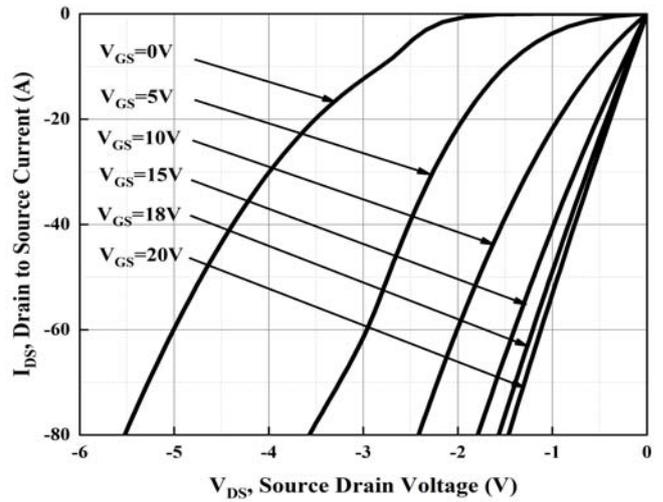


Figure 10. 3rd quadrant Characteristic at Tj= 25 °C

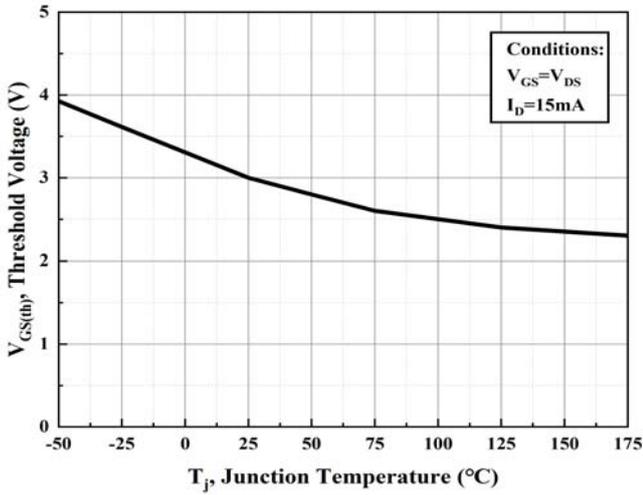


Figure 11. Threshold Voltage vs. Temperature

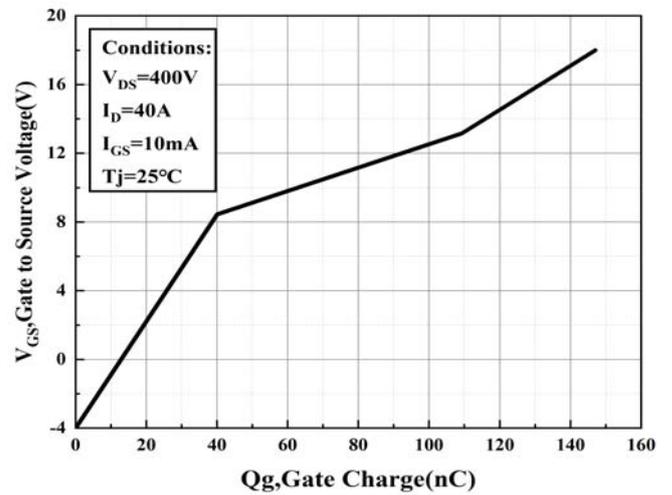


Figure 12. Gate Charge Characteristic

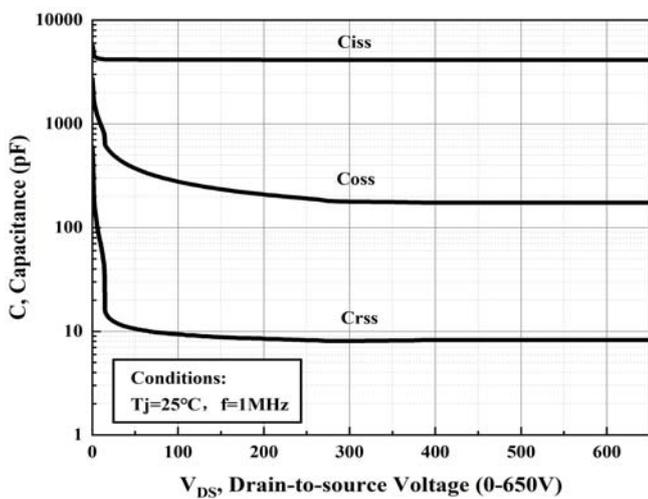


Figure 13. Capacitances vs. Drain Source Voltage (0-650V)

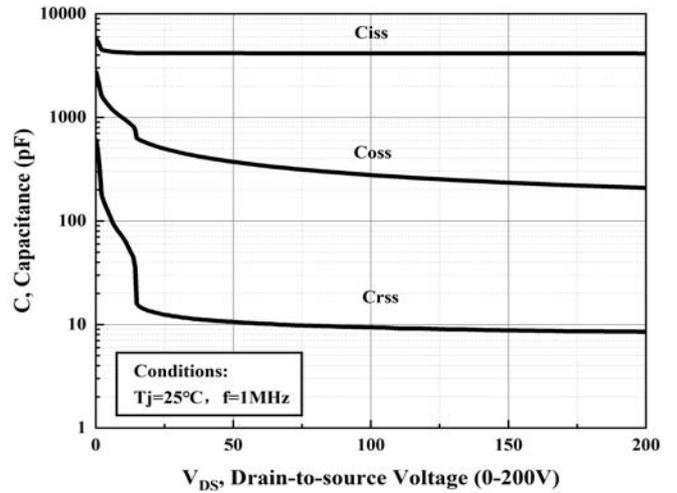


Figure 14. Capacitances vs. Drain Source Voltage (0-200V)

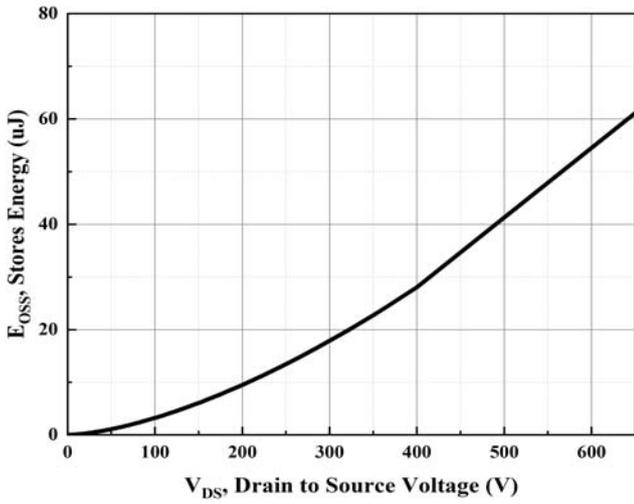


Figure 15. Output Capacitor Stored Energy

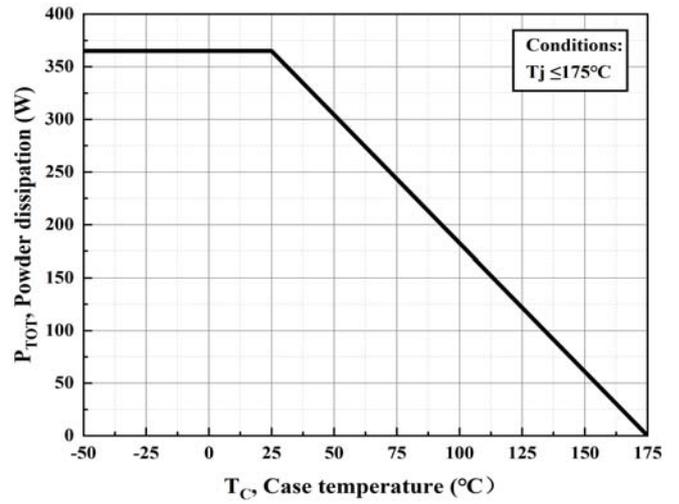


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

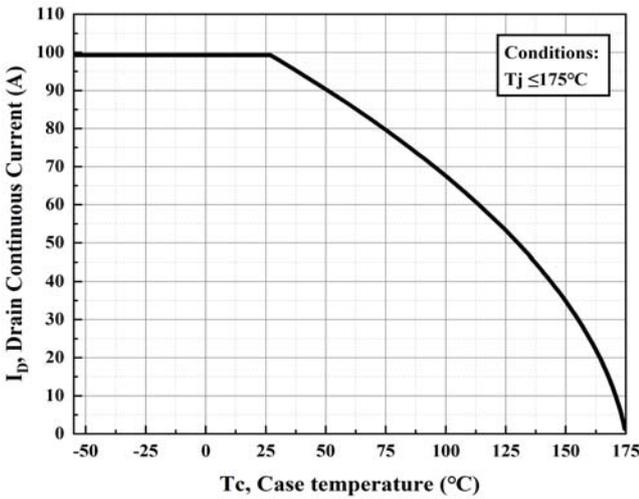


Figure 17. Continuous Drain Current Derating vs. Case Temperature

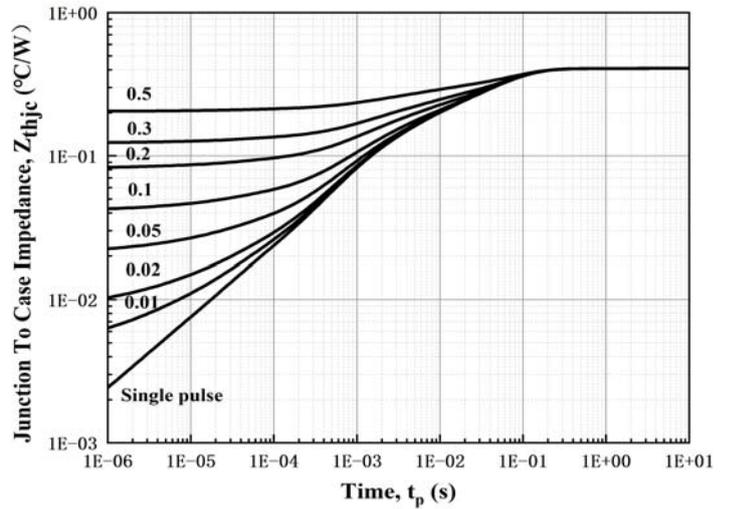


Figure 18 Transient Thermal Impedance (Junction - Case)

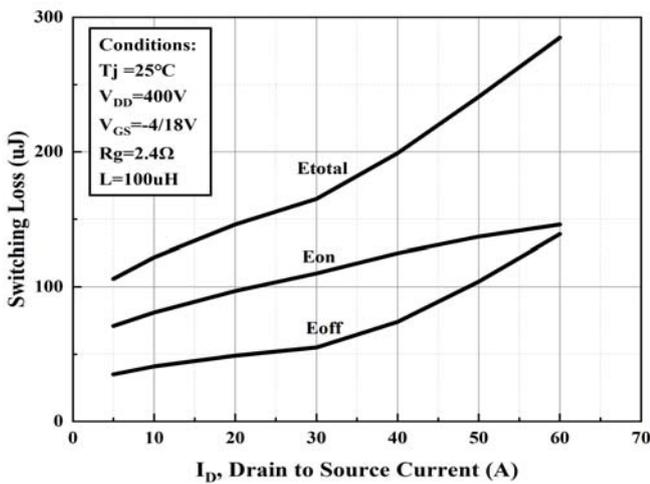


Figure 19. Clamped Inductive Switching Energy vs. Drain Current

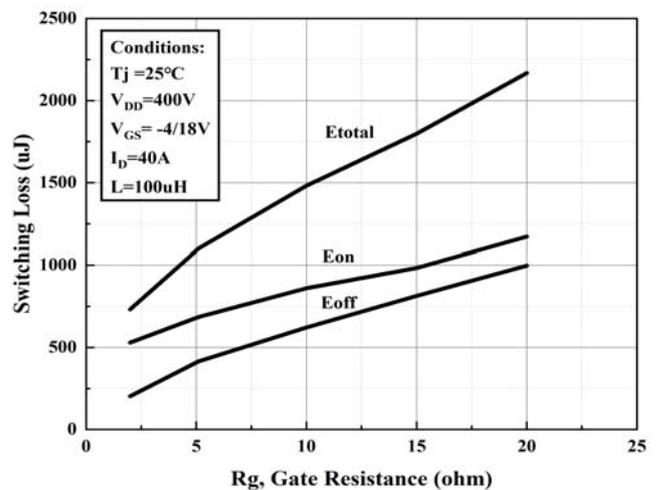


Figure 20. Clamped Inductive Switching Energy vs. R_g

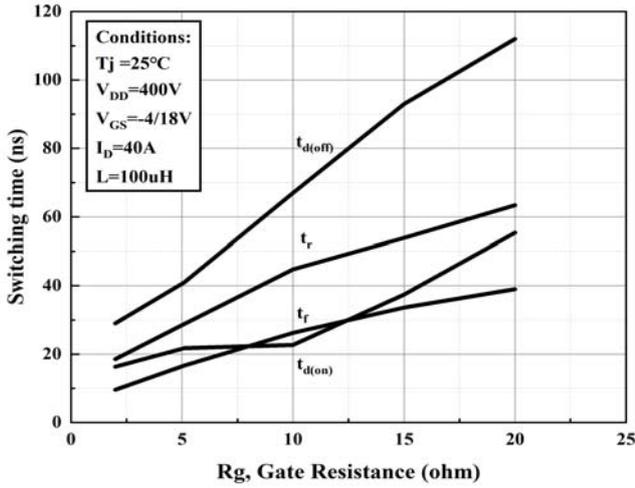


Figure 21. Switching Times vs. Rg

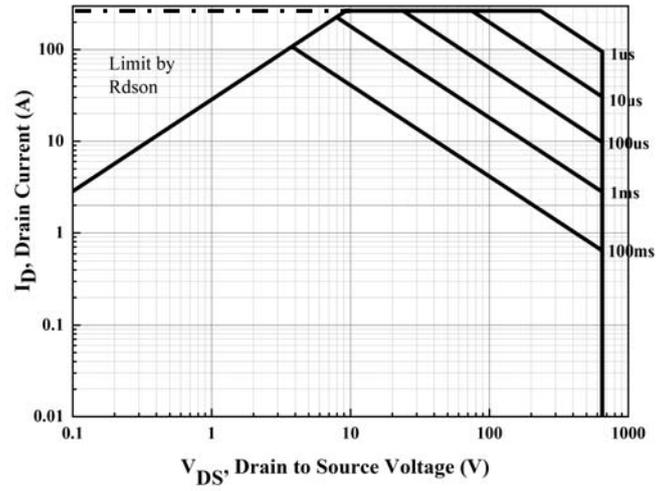


Figure 22. Safe Operating Area

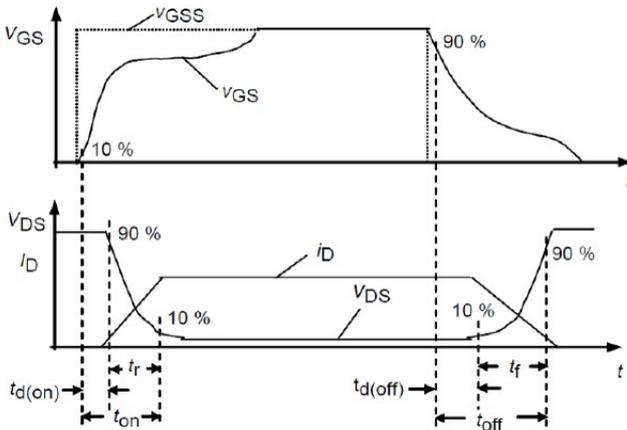


Figure 23. Switching Times Definition

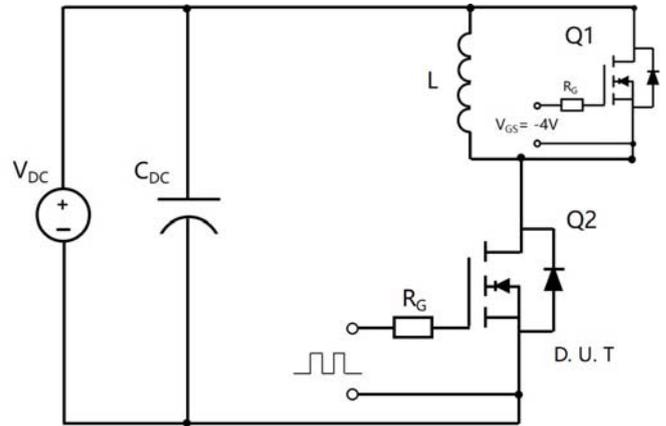
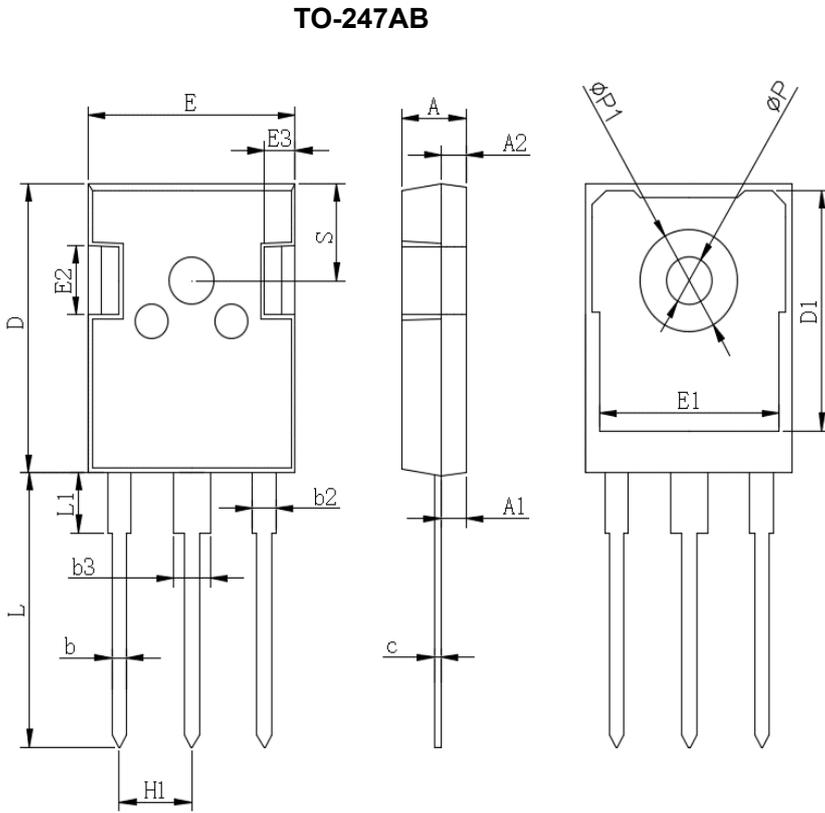


Figure 24. Clamped Inductive Switching Waveform Test Circuit

■Outline Dimensions



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
ΦP	3.40	3.80
$\Phi P1$	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20



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